## SPACE PASSIVE COMPONENT DAYS SPCD

## Wednesday 12th October 2016

Time		Topic	Title	Company
08:30	09:30		Registration Desk Opening	
09:30	09:50	Welcome Speech		
09:50	10:20	Introduction & Instructions Speech		
10:20	10:50	Technology Roadmaps	"European roadmap for passive components"	ESA/CNES/ DLR
10:50	11:10	Normative System & Standards	"SMT approval verification procedure in compliance with new applicable ECSS-Q-ST-70-38 standard"	ESA
11:10	11:40	Break		
11:40	12:00	New Developments	"SAFECAP: Ionic Liquid Supercapacitor"	Hutchinson
12:00	12:20		"Silicon Capacitors - Development and Space Pre- Evaluation"	Alter/Ipdia
12:20	12:40		"Polymer Tantalum Capacitors for Advanced High Reliability Applications"	AVX
12:40	13:00		"Evaluation of a new ceramic dielectric for both low and high voltage applications"	Exxelia Technologies
13:00	14:30	Lunch		
14:30	14:50	New Developments	"Low-loss millimeter-wave self-biased circulators : materials, design and characterization"	Lab-STICC/ UBO
14:50	15:10		"Surface mountable compact Ka-band filter in multilayer micromachining technology"	RF Microtech
15:10	15:30		"Low VSWR high isolation Power divider Ka band"	Cobham Microwave
15:30	15:50		"Nanoprocessing and micromachining technologies of GaN/Si for sensors and filters operating at frequencies above 5 GHz"	IMT Bucharest
15:50	16:20	Break		
16:20	16:40	New Developments	Connector Press-Fit Technology for space-flight applications	CNES
16:40	17:00		Multi-modular power and RF miniature connectors	Axon
17:00	19:00		Poster Session Check the poster session programme	
19:00	20:00		Welcome Drink	

## Thursday 13th October 2016

Time		Topic	Title	Company		
08:30	09:00	Session and Chair Introduction				
09:00	09:20	Technology Roadmaps	"Basic approach of JAXA Parts Program related to Passive Parts"	JAXA		
09:20	09:40	Materials and Processes	"Passive component embedding in printed circuit boards for space applications"	IMEC		
09:40	10:00		"Highest capacitance at higher voltages: Pushing the limits of tantalum high voltage capacitors"	H.C. Starck		
10:00	10:20		"Printed heaters for non-planar space applications"	Fraunhofer IFAM		
10:20	10:40		"Minibend CTR - Phase Invariant Cable Assemblies"	Huber & Suhner Astrolab		
10:40	11:00		"Recent Developments in Coaxial Interconnection Cable Materials to Minimize Temperature Induced Phase Errors"	Times Microwave		
11:00	11:20	Break				
11:20	11:40	Application, Trends & Needs	"Improving overall RF system performance by using coaxial splitters, combiners and couplers with integral isolators"	Airbus D&S		
11:40	12:00		"Improving Signal Integrity performance in high speed integrated circuit packages with application of coaxial wirebonding technology"	Rosenberger		
12:00	12:20		"Spring probe contact solutions for solderless interconnections (Interposers)"	Smiths Connectors		
12:20	12:40		"Why and how to use tantalum capacitors in satellites secondary DC Bus?"	Exxelia Supply		
12:40	12:45	Technical Introduction of Manufacturers (TIMs)	"European Passive Components Institute Introduction"	EPCI		
12:45	12:50		"ACSIEL MIL-AEROSPACE Working Group"	ACSIEL		
12:50	12:55		"Very High power TNC connectors"	<b>R</b> adiall		
12:55	13:00		"New Thermostat 100 VDC"	Comepa Industries		
13:00	13:05		"Space Splice, What is it?"	C&K		
13:05	14:30	Lunch				
14:30	14:50	Technology Roadmaps	"TAS Roadmap for Passive Components"	TAS		
14:50	15:10		"Capacitors for ultra-low power hybrid circuits"	Medtronic		
15:10	15:30	Application, Trends & Needs	"Evaluation and Qualification of Commercial Off-The- Shelf Supercapacitors for Space Applications"	Airbus D&S		
15:30	15:50		"High data rate solutions with new cable and connector technologies"	Axon		
15:50	16:20		Break			
16:20	16:40	Application, Trends & Needs	"Piezoelectric components for usual space and cryogenic environment"	Cedrat Technologies		
16:40	17:00		"Assessment of the Rules on Heater De-Rating"	OHB System		
17:00	18:00	"Commercial vs	Interactive panel discussion on:  COTS+ vs. Qualified passive components for space application	ons"		

19:30 00:00 Gala Dinner

## Friday 14th October 2016

Time		Topic	Title	Company	
08:30	09:00	Session and Chair Introduction			
09:00	09:20	Technology Roadmaps	"ADS Roadmap for passive components"	Airbus D&S	
09:20	09:40	Test, Reliability & Evaluation for space	"ESTEC's Materials and Electrical Components Laboratory capabilities on testing passive components"	ESA	
09:40	10:00		"Feedback of 5 years of failure analysis on passive components from all electronic sectors"	Serma Technologies	
10:00	10:20		"Effects of ambient atmosphere on reliability of solid tantalum capacitors"	Kemet Electronics	
10:20	10:40		"Evaluation of 10V chip polymer tantalum capacitors for space applications"	ASRC	
10:40	11:00		"Design, Manufacture and Test Techniques for Multipactor Free RF Devices"	Sierra Microwave Technology	
11:00	11:30	Break			
11:30	11:50	Evaluation & Qualification	"Evaluation and qualification of ferrite isolators and circulators for space applications"	Cobham Microwave	
11:50	12:10		"SMP-LOCK® The Ultimate Secure Connection"	Radiall	
12:10	12:30		"Custom-designed circuit protection solutions for future space applications"	Schurter	
12:30	12:35	Technical Introduction of Manufacturers (TIMs)	"Exxelia Group, 30 years expertise in the design and manufacture of passive components for Space"	Exxelia	
12:35	12:40		"H.C. Starck, whenever it is about Ta, W, Nb, Mo and Re"	H.C. Starck	
12:40	12:45		"High performance space OCXO"	Rakon	
12:45	12:50		"Introduction to Gore Microwave Cable Assemblies"	Gore	
12:50	12:55		"New Temperature sensors for space applications"	Innovative Sensor Technology	
12:55	13:00		"Interconnect solutions for space applications"	Nicomatic	
13:00	14:30	Lunch			
14:30	14:50		"Miniaturization Of Metallized Polyester Film Capacitors"	Exxelia Technologies	
14:50	15:10	Evaluation & Qualification	"Tantalum SMD capacitors with manganese dioxide and conductive polymer counter electrode for space applications"	<b>K</b> emet	
15:10	15:30		"Ultra-High Reliability Space OCXO & 4-Point Mount 5x7mm SMT Hybrid Oscillator Space Qualified"	Q-Tech Corporation	
15:30	16:00		Closing Session & Award Ceremony		